

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5896519

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HAYATO NAKANO	11/05/2019
RECEIVING PARTY DATA	
Name:	FUJI ELECTRIC CO., LTD.
Street Address:	1-1, TANABESHINDEN, KAWASAKI-KU
Internal Address:	KAWASAKI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	210-9530
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16735696
CORRESPONDENCE DATA	
Fax Number:	(000)000-0000
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(408) 213-8153
Email:	usdoCKET@ryuka.com
Correspondent Name:	RYUKA USA LLP
Address Line 1:	111 NORTH MARKET STREET
Address Line 2:	SUITE 300
Address Line 4:	SAN JOSE, CALIFORNIA 95113
ATTORNEY DOCKET NUMBER:	FE-0548US
NAME OF SUBMITTER:	ADAM S. LANGLEY
SIGNATURE:	/Adam S. Langley/
DATE SIGNED:	01/07/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 1	
source=FE-0548US_Declaration_and_Assignment#page1.tif	

Applicant Ref. No. : 18P00703US
Attorney Docket No. : FE-0548US

COMBINED DECLARATION(37 CFR § 1.63) FOR UTILITY DESIGN APPLICATION
USING AN APPLICATION DATA SHEET (37 CFR § 1.76) AND ASSIGNMENT

As the below named inventor, I hereby declare that:

This declaration is directed to the application entitled EXTERNAL CONNECTION PART OF SEMICONDUCTOR MODULE, SEMICONDUCTOR MODULE, EXTERNAL CONNECTION TERMINAL, AND MANUFACTURING METHOD OF EXTERNAL CONNECTION TERMINAL OF SEMICONDUCTOR MODULE, and bearing Attorney Docket No. FE-0548US.

The above-identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS I, the undersigned inventor, hereafter also referred to as "assignor", have invented certain new and useful improvements described in the above identified application; and

WHEREAS, FUJI ELECTRIC CO., LTD. hereinafter also referred to as "assignee", whose address is 1-1, Tanabeshinden, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-9530 Japan, is desirous of acquiring the entire right, title and interest in and to the application and invention, and to any United States patents to be obtained therefor;

NOW, THEREFORE, for valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title, and interest in the application and the invention disclosed therein for the United States of America, including all divisions and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including any right to bring or maintain an action for infringement under the provisional rights granted pursuant to Title 35, Section 154 of the United States Code or any other cause of action for acts which would constitute infringement occurring prior to this assignment, and including the right to claim priority under the International Conventions of Paris (1883), as amended, of or in any corresponding foreign patent application, and I request the Director of the U. S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns.

Legal Name of Inventor Hayato NAKANO

Inventor's Signature Hayato Nakano

Date November 5, 2019